

Part Number : 1SC3528VGB01MH08

Specification: TC0120A20A07000

Documents No.: BT-35-1011003

Prepared By: Huanhuan. Yi

Chece By:

Time: 2012/03/16

Customer Confirmation:

Features

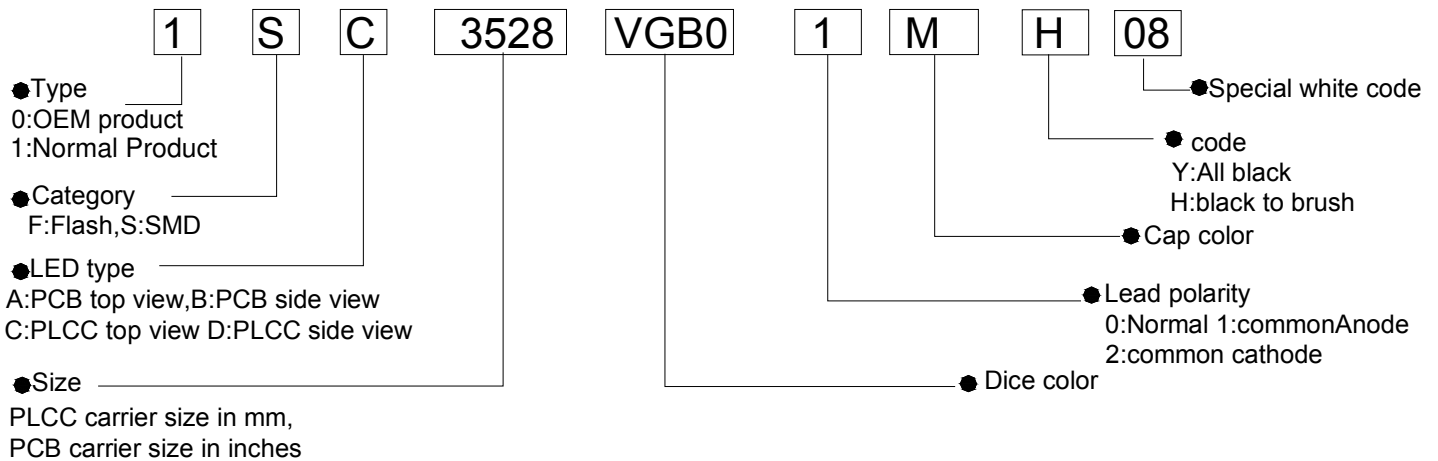
- § 3.5mmx2.8mm SMT LED , 1.9mm Thickness.
- § Low Power Consumption.
- § Viewing Angle 120°.
- § Various Colors And Types Available.
- § Package : 2000 PCS/Reel.
- § Resin(Mold): Silicone
- § Dice: Red(AlGaInP) Green InGaN Blue InGaN
- § Pulsed Forward Current 100 mA (Duty 1/10, Pulse Width 0.1ms.)
- § Reverse Voltage:5 V
- § Operating Temperature: -40~ +80°C
- § Storage Temperature: -40 ~ +100°C
- § Soldering Temperature: 260for10sec°C

Electrical-Optical Characteristics Ta=25

Parameter	Symbol		Value			Unit	Test condition
			Min.	Typ.	Max.		
Forward Voltage	Vf	R	1.8	1.9	2.6	V	If=20mA
		G	2.8	3.2	3.8	V	If=20mA
		B	2.8	3.2	3.8	V	If=20mA
Luminous intensity	Iv	R	160	235		mcd	If=20mA
		G	648	1000		mcd	If=20mA
		B	160	235		mcd	If=20mA
Wavelength	d	R	615		630	(nm)	If=20mA
		G	519		534	(nm)	If=20mA
		B	461		476	(nm)	If=20mA
Reverse Current	Ir				10	A	Vr=5V
Viewing angle	2			120			If=20mA
Junction Temperature	Tj		110				If=20mA
Electrostatic Discharge Classification	ESD		1000V				

- Luminous intensity (IV) 10%, Forward Voltage (VF) 0.1V, Wavelength(d) 0.5nm
- IS standard testing
- Junction Temperature R=G=B=110
- Electrostatic Discharge Classification R=G=B=1000V

Product Identification Code





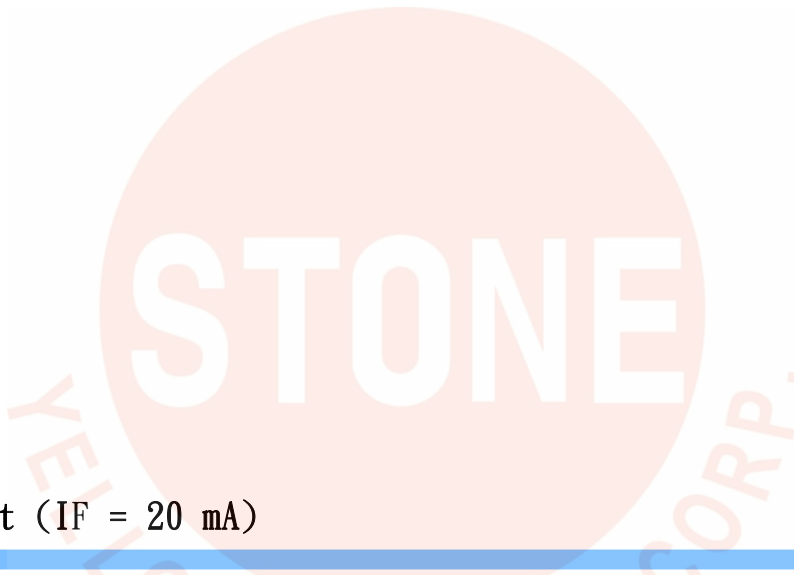
Intensity Bin Limit (IF = 20 mA)

Red		
Bin Code	Min. (mcd)	Max. (mcd)
7	160	200
9	200	250
9	250	310

Green		
Bin Code	Min. (mcd)	Max. (mcd)
9	640	800
10	800	1000
11	1000	1250

Blue		
Bin Code	Min. (mcd)	Max. (mcd)
7	160	200
8	200	250
9	250	310

Tolerance of measurement of luminous intensity is 10%.



Color Bin Limit (IF = 20 mA)

Red		
Bin Code	Min. (nm)	Max. (nm)
2	615	620
3	620	625
4	625	630

Green		
Bin Code	Min. (nm)	Max. (nm)
2	519	524
3	524	529
4	529	534

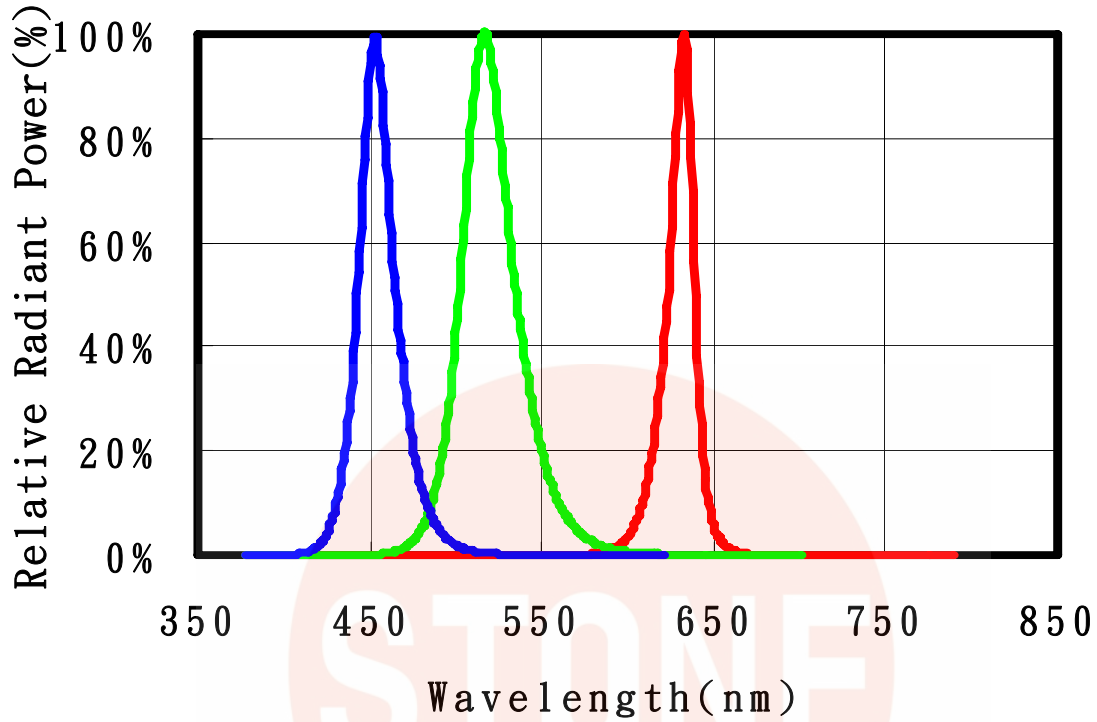
Blue		
Bin Code	Min. (nm)	Max. (nm)
7	461	466
8	466	471
9	471	476

Tolerance of measurement of dominant wavelength is 1 nm.

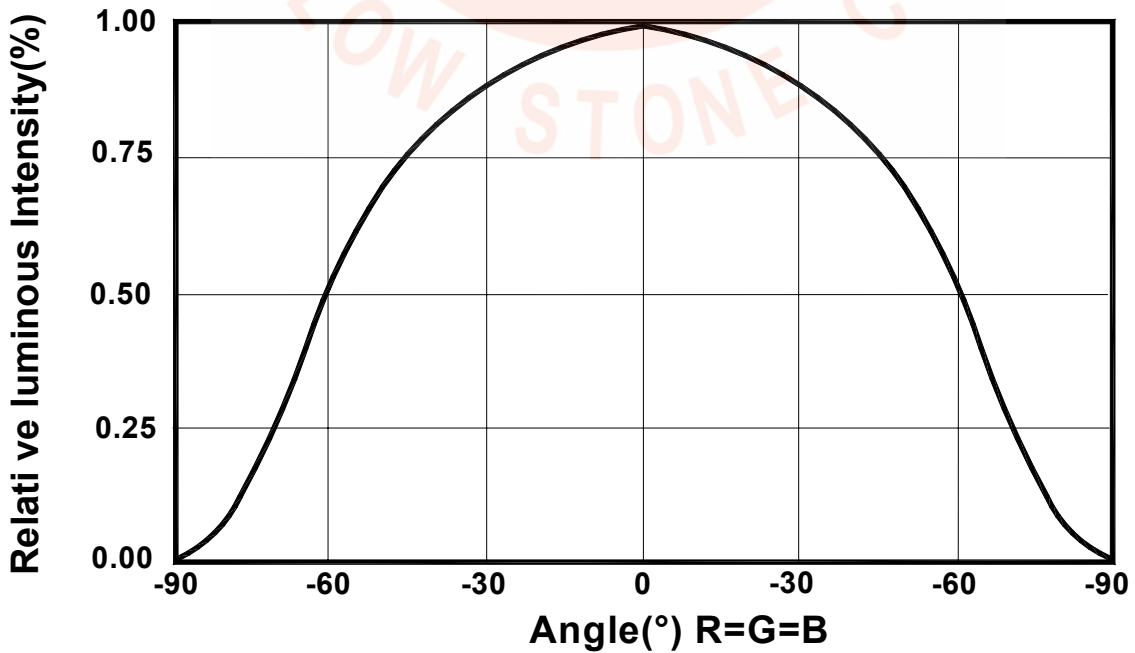
- ◆ Please check sorting method, We will amend the Bin code to maintain Bin Code centralize .

Optical Characteristics

Relative Spectral Power Distribution(Ta=25)

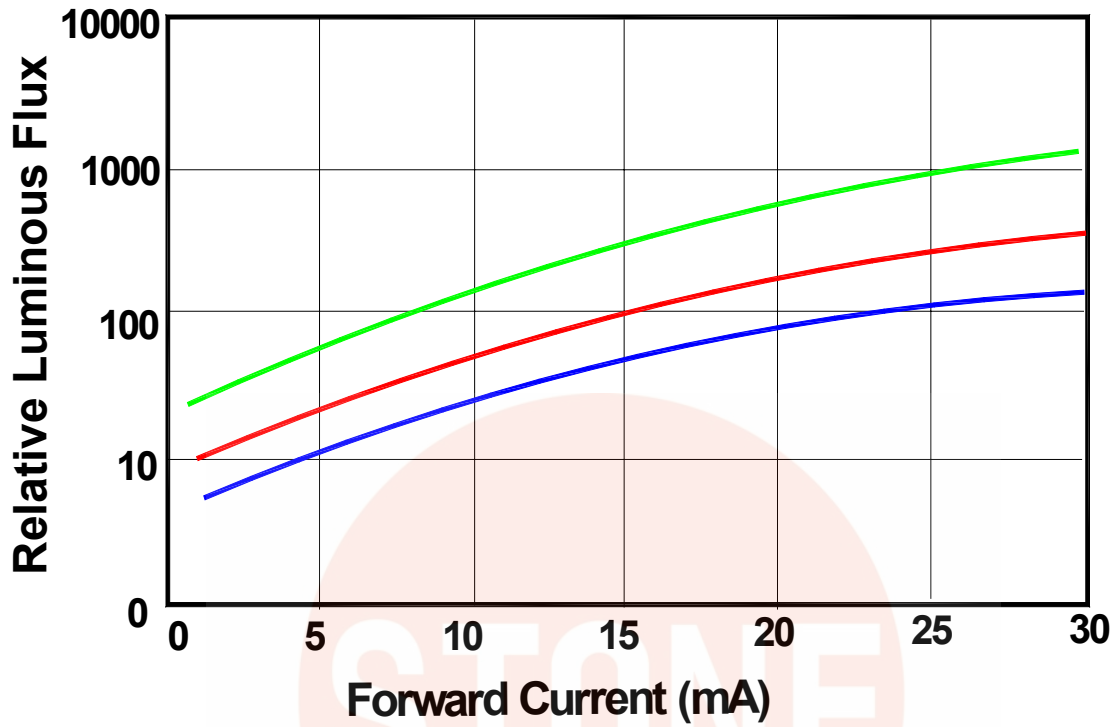


Typical Spatial Distribution

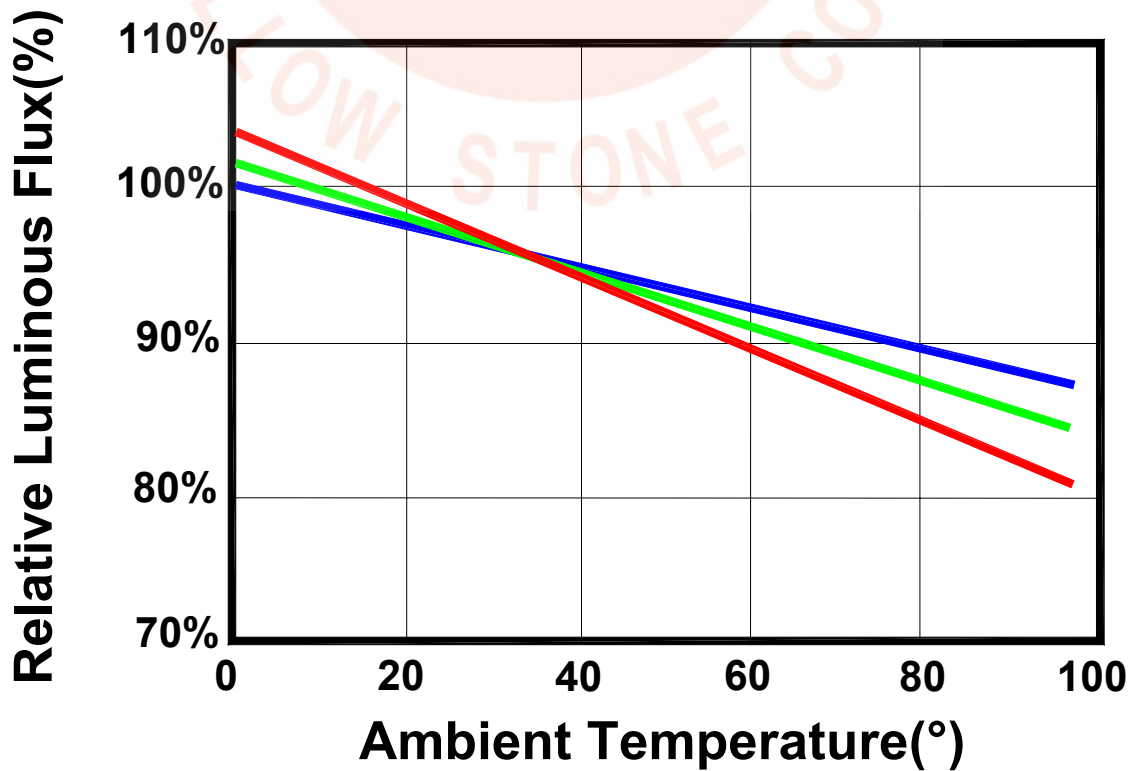




Relative Flux vs. Current (Ta=25)

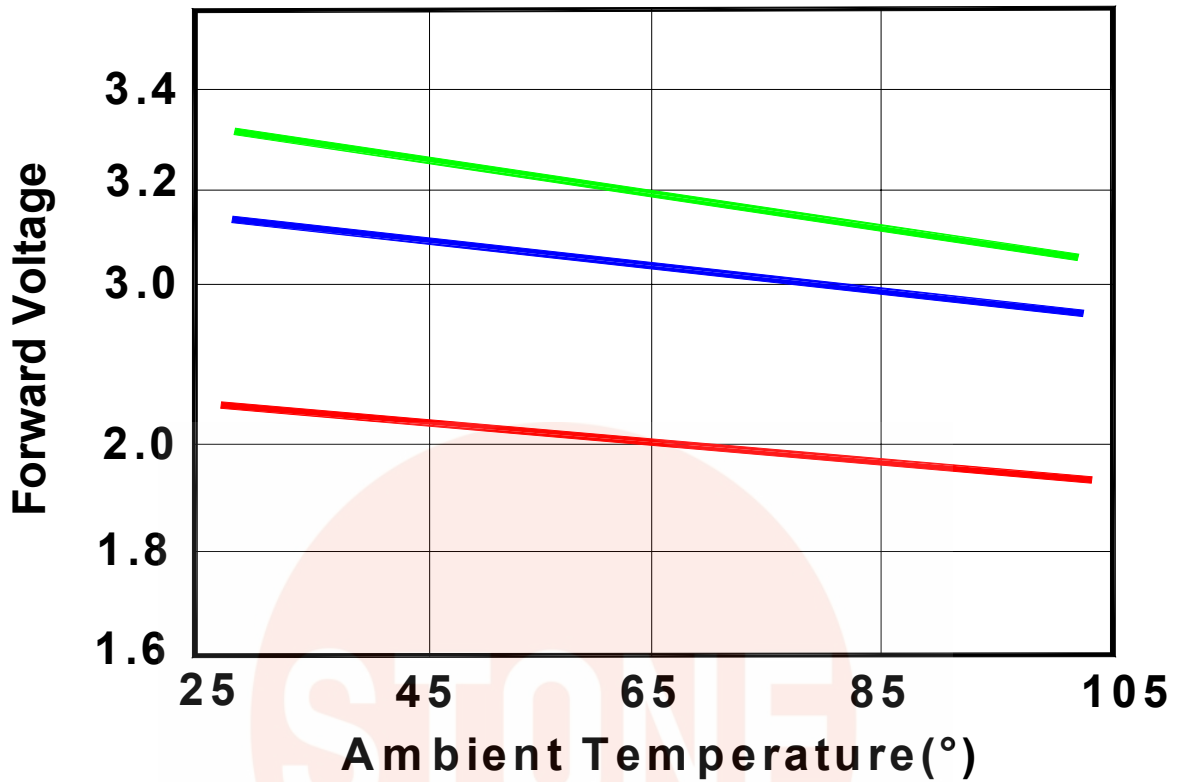


Relative Flux vs. Ambient Temperature

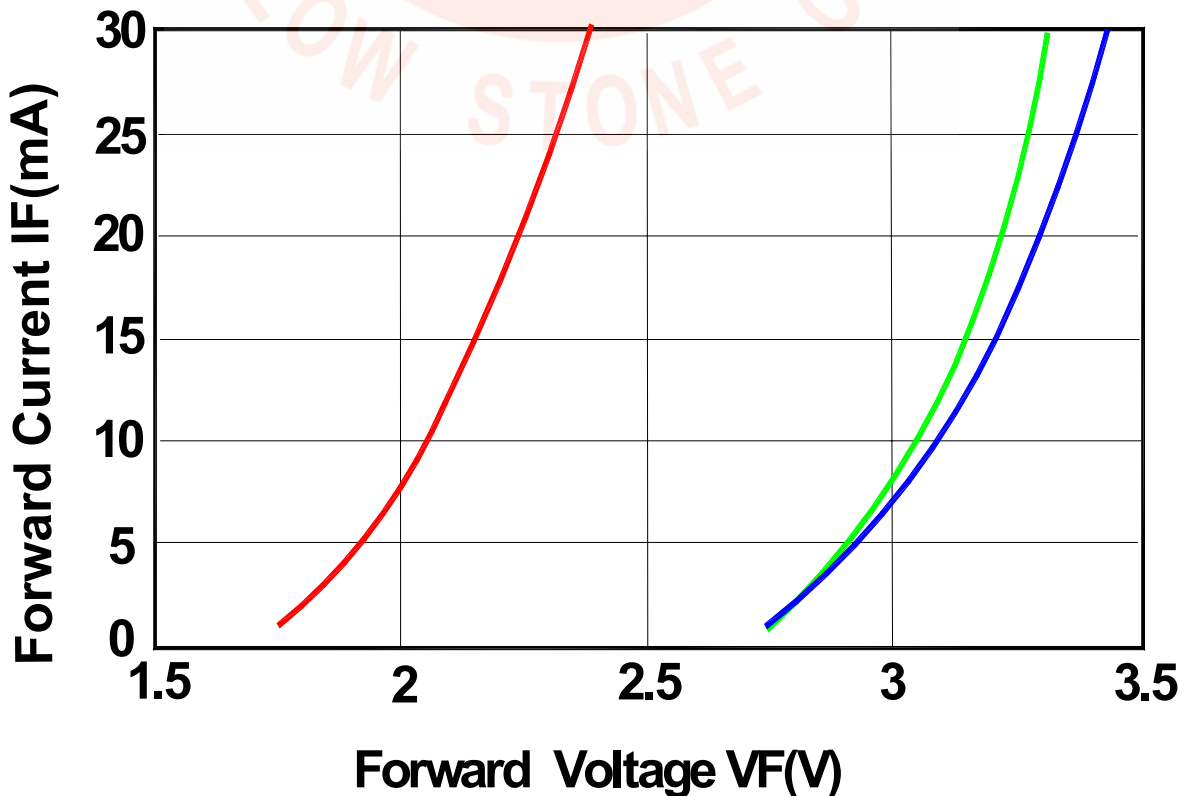




Forward Voltage .Ambient Temperature

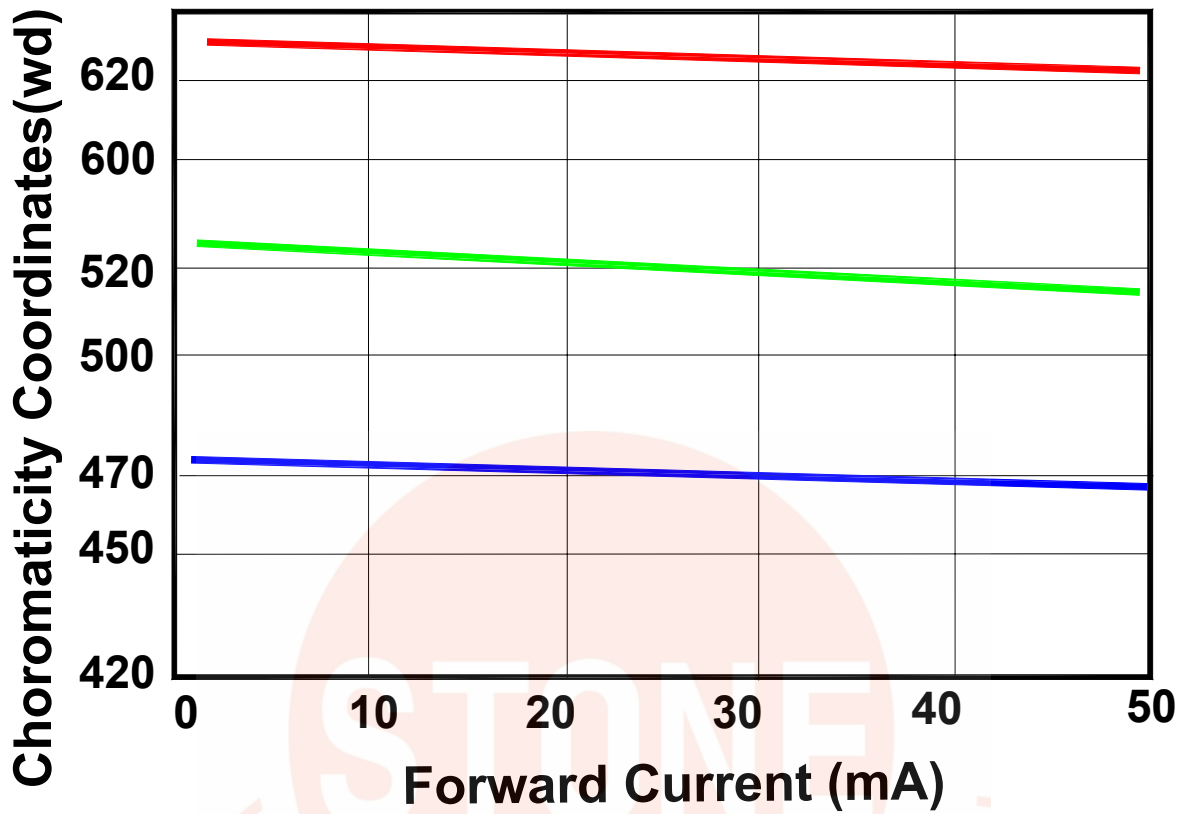


Electrical Characteristics (Ta=25)

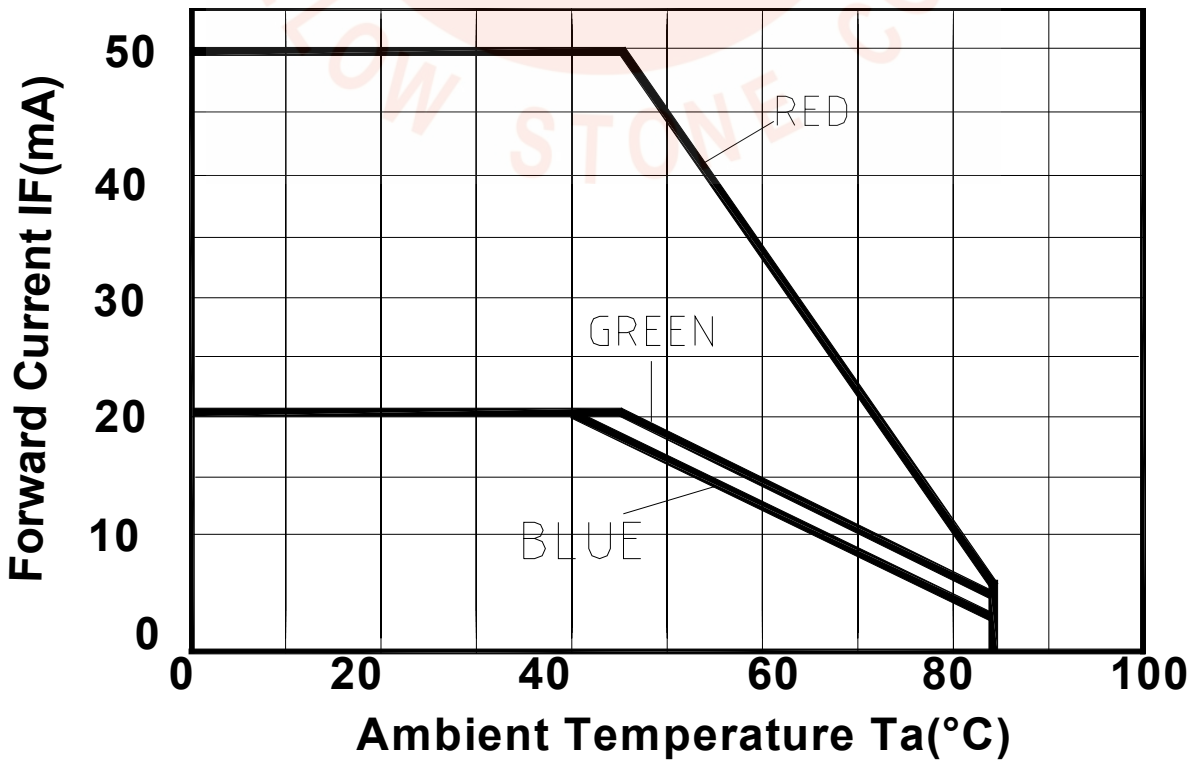




Chromaticity Coordinates .Forward Current

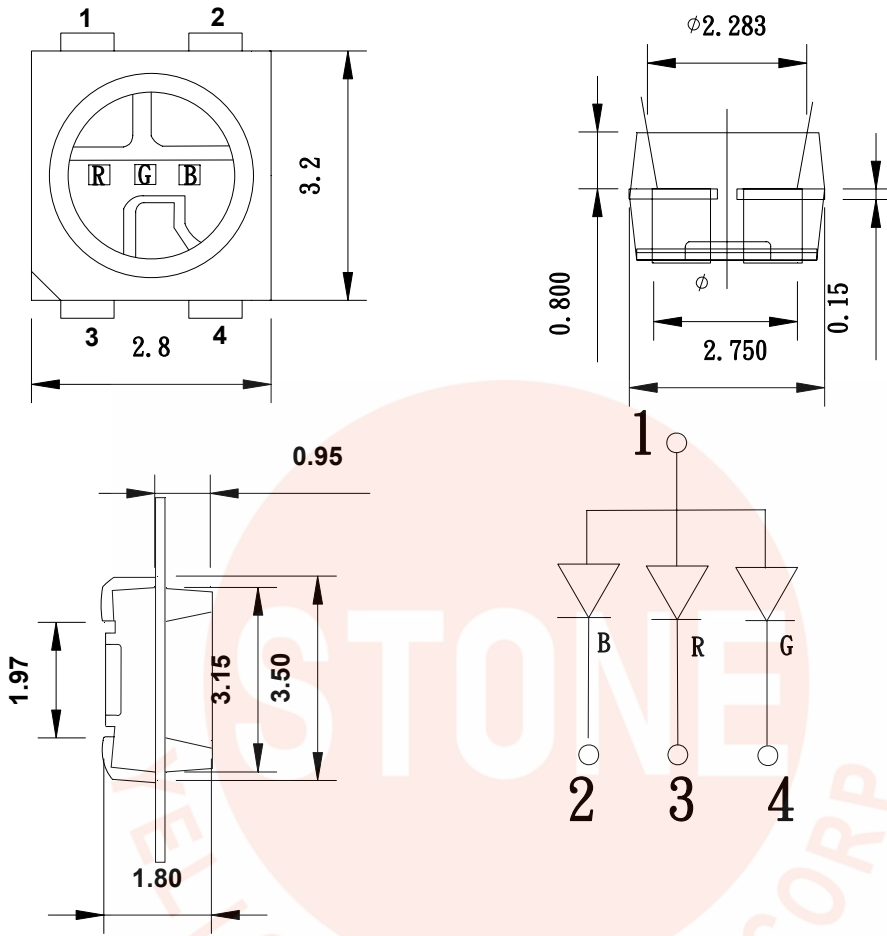


Thermal Design

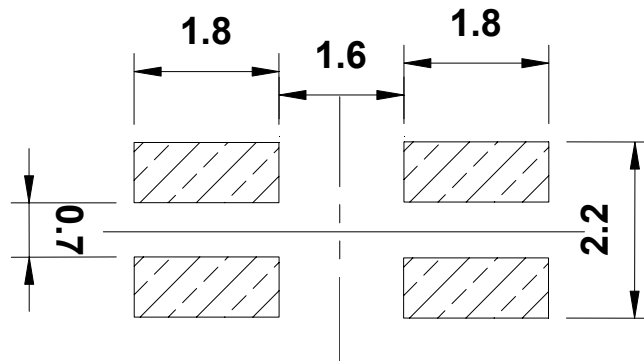




Outline Dimensions



Recommend Padlayout



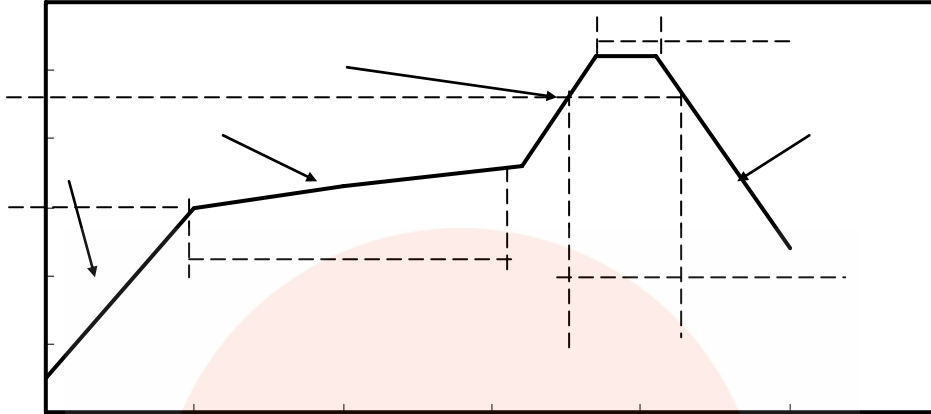
- § All dimensions are in millimeters.
- § Tolerance is ± 0.1 unless other specified
- § Specifications are subject to change without notice.

Reflow Profile

■ Reflow Temp/Time

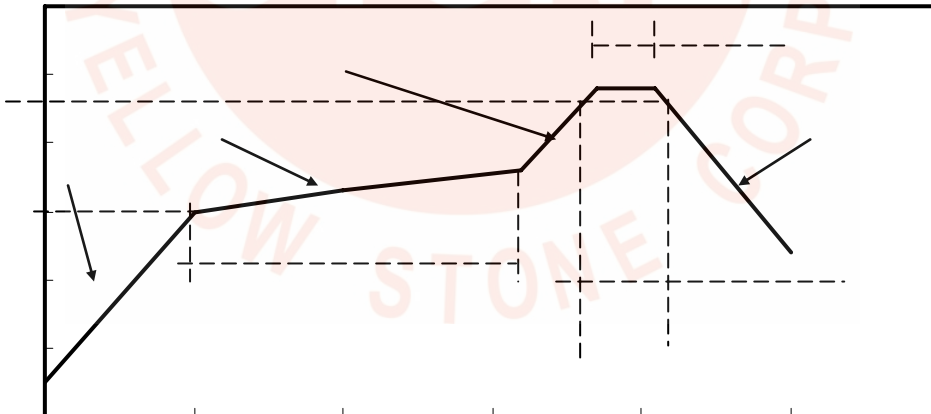
IR reflow soldering Profile

Lead Free solder



IR reflow soldering Profile

Lead solder



NOTES:

1. We recommend the reflow temperature 240 (± 5), the maximum soldering temperature should be limited to 260.
2. Don't cause stress to the silicone resin while it is exposed to high temperature.
3. Number of reflow process shall be 1 time.



Test items and results of reliability

Test Item	Test Conditions	Duration/ Cycle	Number of Damage	Reference
Temperature Cycle	-40 30min 25 (5 min) 100 30min	100 cycle	0/22	JEITA ED-4701 300 303
Thermal Shock	-40 30min 5sec 110 30min	100 cycle	0/22	JEITA ED-4701 200 303
High Temperature Storage	$T_a=100$	1000 hrs	0/22	EIAJED-4701 200 201
Humidity Heat Storage	$T_a=85$ RH=85%	1000 hrs	0/22	EIAJED-4701 100 103
Low Temperature Storage	$T_a=-40$	1000 hrs	0/22	EIAJED-4701 200 202
Life Test	$T_a=25$ IF=20mA	1000 hrs	0/22	Tested with Brightek standard
High Humidity Heat Life Test	60 RH=90% IF=20mA	1000 hrs	0/22	Tested with Brightek standard
Low Temperature Life Test	$T_a=-40$ IF=20mA	1000 hrs	0/22	Tested with Brightek standard
ESD(HBM)	1KV at 1.5k Ω ;100pf	3 Time	0/22	MIL-STD-883D

*Criteria for Judging the Damage

Item	Symbol	Condition	Criteria for Judgement	
			MIN	MAX
Forward Voltage	VF	IF=20mA	-	USL* ¹ ×1.1
Reverse Current	IR	VR=5V	-	10 μ A
Luminous Intensity	Iv	IF=20mA	LSL* ² ×0.7	-

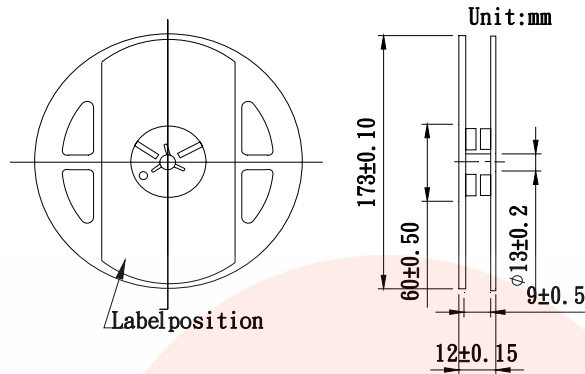
[Note]*¹USL:Upper Specification Level

*² LSL: Lower Specification Level

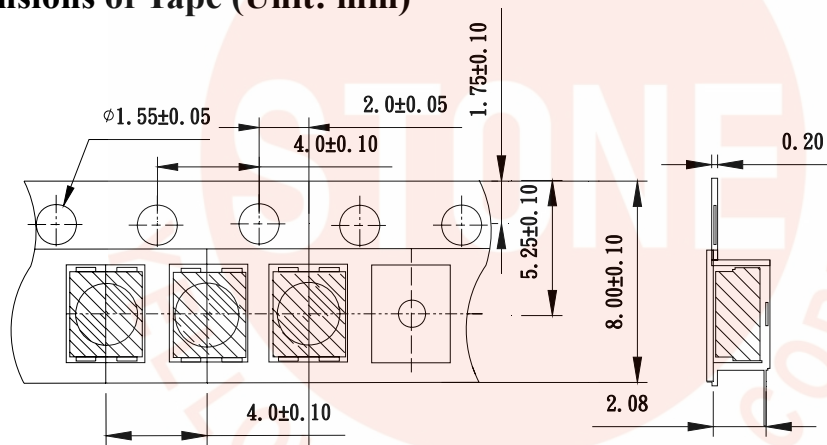
Packing

3528 Single-Color High Performance SMD Top LEDs Packaging Specifications

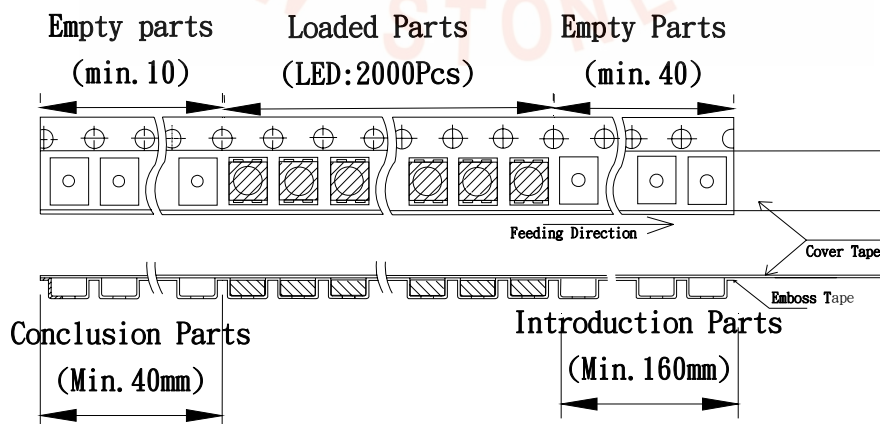
● Dimensions of Reel (Unit: mm)



● Dimensions of Tape (Unit: mm)



● Arrangement of Tape

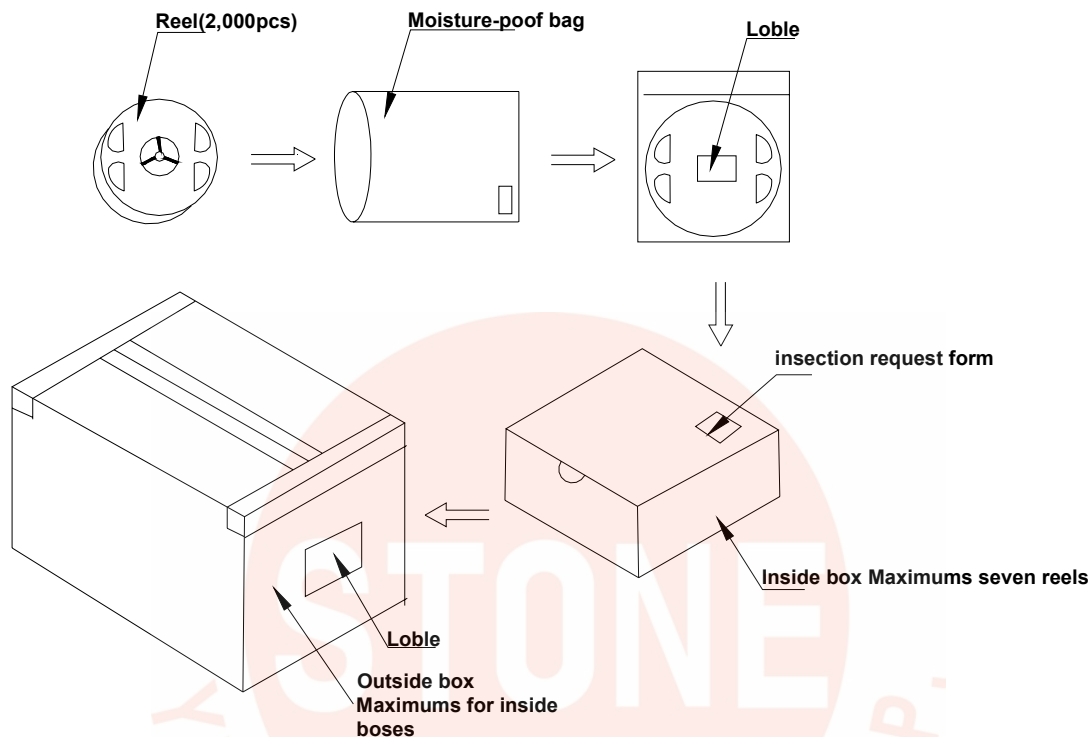


NOTES

1. Empty component pockets are sealed with top cover tape;
2. The maximum number of missing smds is two;
3. The cathode is oriented towards the tape sprocket hole in accordance with ANSI/EIA RS-481 specifications;
4. 2,000pcs/Reel

3528 Single-Color High Performance SMD Top LEDs Packaging Specifications

- Packaging specifications

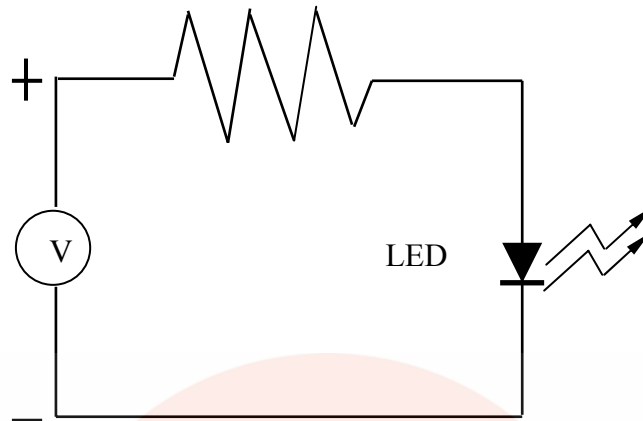


NOTES:

Reeled products (The most numbers of products are 2,000pcs) packed in a seal off moisture-proof bag along with a desiccant one by one, Seven moisture-proof bag of maximums (total maximum number of products are 14,000pcs) packed in an inside box (size: about 238mm x about 194mm x about 102mm) and four inside boxes of maximums are put in the outside box (size: about 410mm x about 254mm x about 229mm) Together with buffer material, and it is packed. (Part No., Lot No., quantity should appear on the label on the moisture-proof bag, part No. And quantity should appear on the insection request form on the cardboard box.) .

Test circuit and handling precautions

■ Test circuit



■ Handling precautions

1. Over-current-proof

Customer must apply resistors for protection; otherwise slight voltage shift will cause big current change (Burn out will happen).

2.Storage

2.1 It is recommended to store the products in the following conditions:

Humidity: 60% R.H. Max.

Temperature : 5 ~30 (41 ~86)

2.2 Shelf life in sealed bag: 12 month at 5 ~30 and 60% R.H. after the package is Opened, the products should be used within a week or they should be keeping to stored at 20%R.H. with zip-lock sealed.

3.Baking

It is recommended to baking before soldering when the pack is unsealed after 24hrs. The Conditions are as followings:

3.1 70 3 x 24hrs and 5%RH, taped reel type

3.2 100 3 x 2hrs , bulk type

3.3 130 3 x(15~30min), bulk type

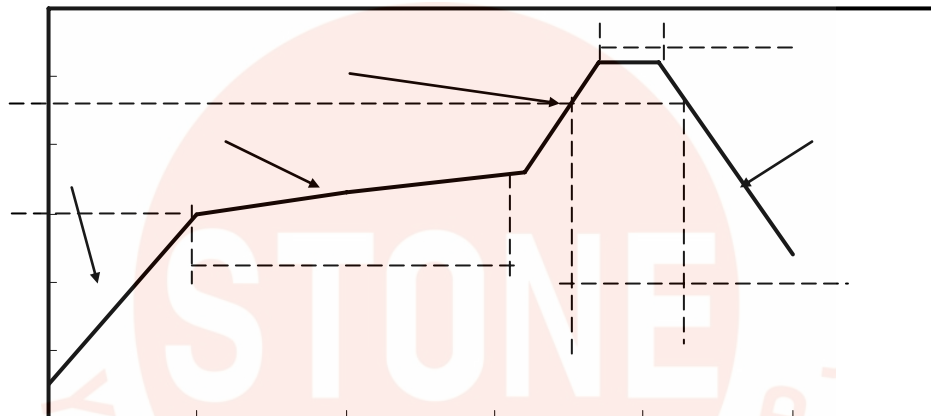
LED Usage and Handling Instructions

No.1 soldering

A It is not better to be manual soldering

B Reflow soldering

1 Soldering according to the following temperature chart is highly recommended



2 Soldering paste

Use soldering paste with the melting point at 230 is recommended

No.2 Collet

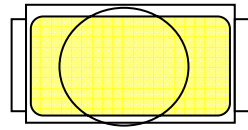
(1) Abnormal situation caused by improper setting of collet

To choose the right collet is the key issue in improving the product's quality. LED is different from other electronic components, which is not only about electrical output but also for optical output. This characteristic made LED more fragile in the process of SMT. If the collet's lowering down height is not well set, it will bring damage to the gold wire at the time of collet's picking up and loading which will cause the LED fail to light up, light up now and then or other quality problems

(2) How to choose the collet

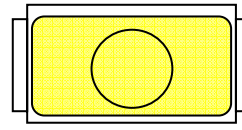
During SMT, please choose the collet that has larger outer diameter than the lighting area of lens, in case that improper position of collet will damage the gold wire inside the LED. Different collets fit for different products, please refer to the following pictures cross out:.

Outer diameter of collet should be larger than the lighting area



Picture 1 ✓

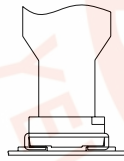
Outer diameter of collet



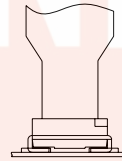
Picture 2 ✗

3 How to set the height of collet

The reason why for top view SMD, the height of collet before it presses downward will directly affect the quality of products during SMT is that if the collect go down too much, it will press lens and cause the distortion or breaking of gold wire. The setting of collet position should follow the pictures belowed.



Picture 3 ✓



Picture 4 ✗

No.3 Other points for attention

- A No pressure should be exerted to the epoxy shell of the SMD under high temperature.
- B Do not scratch or wipe the lens since the lens and gold wire inside are rather fragile and cross out easy to break.
- C LED should be used as soon as possible when being taken out of the original package, and should be stored in anti-moisture and anti-ESD package.

No.4 This usage and handling instruction is only for your reference.